

Product Summary

| $V_{(BR)DSS}$ | $R_{DS(on)MAX}$ | I_D |
|---------------|-----------------|-------|
| 60V | 80mΩ@10V | 3A |
| | 95mΩ@4.5V | |

Feature

- Trench power LV MOSFET technology
- High speed switching

Application

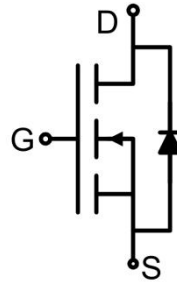
- Power switching application
- Uninterruptible power supply
- PWM application

Package

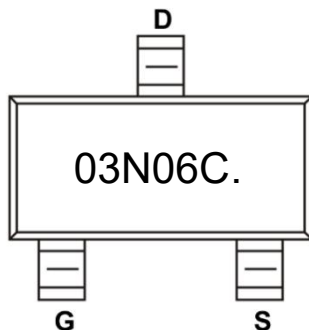


SOT-23

Circuit diagram



Marking



Absolute maximum ratings (T_A=25°C unless otherwise noted)

| Parameter | Symbol | Value | Unit |
|--|------------------------|------------|------|
| Drain-Source Voltage | V _{DS} | 60 | V |
| Gate-Source Voltage | V _{GS} | ±20 | V |
| Continuous Drain Current | I _D | 3 | A |
| Continuous Drain Current (T _A =100°C) | I _D (100°C) | 1.9 | A |
| Pulsed Drain Current ¹⁾ | I _{DM} | 20 | A |
| Power Dissipation ²⁾ | P _D | 1.2 | W |
| Thermal Resistance Junction to Ambient ³⁾ | R _{θJA} | 105 | °C/W |
| Operating Junction Temperature | T _J | 150 | °C |
| Storage Temperature | T _{STG} | -55 ~ +150 | °C |

Electrical characteristics (T_J=25 °C, unless otherwise noted)

| Parameter | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|---|----------------------|--|------|------|------|------|
| Static Characteristics | | | | | | |
| Drain-source breakdown voltage | V _{(BR)DSS} | V _{GS} = 0V, I _D = 250μA | 60 | | | V |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = 60V, V _{GS} = 0V | | | 1 | μA |
| Gate-body leakage current | I _{GSS} | V _{GS} = ±20V, V _{DS} = 0V | | | ±100 | nA |
| Gate threshold voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250μA | 0.9 | 1.3 | 2 | V |
| Drain-source on-resistance | R _{DS(on)} | V _{GS} = 10V, I _D = 3A | | 60 | 80 | mΩ |
| | | V _{GS} = 4.5V, I _D = 2A | | 70 | 95 | |
| Dynamic characteristics⁴⁾ | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} = 30V, V _{GS} = 0V, f = 1MHz | | 400 | | pF |
| Output Capacitance | C _{oss} | | | 28 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 23 | | |
| Gate Charge | Q _g | V _{DS} = 30V, V _{GS} = 10V, I _D = 3A | | 8.8 | | nC |
| Gate-Source Charge | Q _{gs} | | | 1 | | |
| Gate-Drain Charge | Q _{gd} | | | 2.5 | | |
| Turn-on delay time | t _{d(on)} | V _{DD} = 30V, V _{GS} = 10V, I _D = 3A R _{GEN} = 2.3Ω | | 4.5 | | nS |
| Turn-on rise time | t _r | | | 10 | | |
| Turn-off delay time | t _{d(off)} | | | 12.5 | | |
| Turn-off fall time | t _f | | | 1.5 | | |
| Source-Drain Diode characteristics | | | | | | |
| Diode Forward current | I _S | | | | 3 | A |
| Diode Forward voltage | V _{SD} | V _{GS} = 0V, I _S = 3A | | | 1.2 | V |
| Reverse Recovery Time | t _{rr} | I _F = 3A, di/dt = -500A/μs | | 12 | | nS |
| Reverse Recovery Charge | Q _{rr} | | | | 24 | |

Notes:

- 1) Repetitive rating; pulse width limited by max. junction temperature.
- 2) P_d is based on max. junction temperature, using junction-case thermal resistance.
- 3) The value of R_{θJA} is measured with the device mounted on the minimum recommend pad size, in the still air environment with T_A = 25°C. The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.
- 4) Guaranteed by design, not subject to production testing.

Typical Characteristics

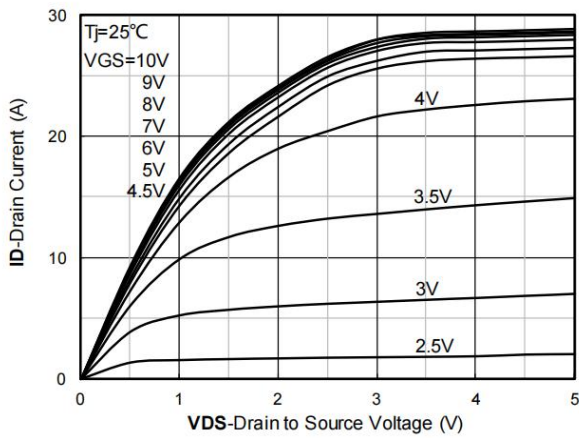


Figure 1. Output Characteristics

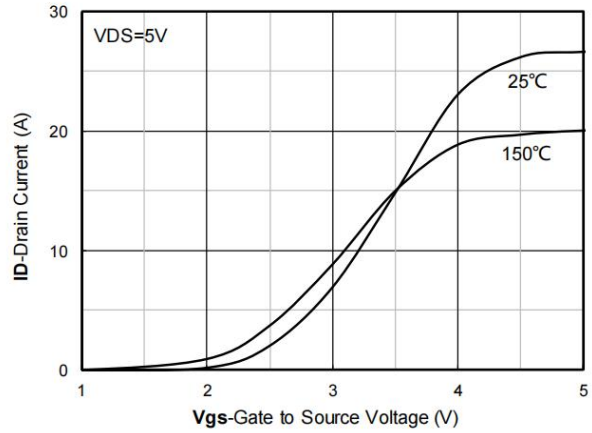


Figure 2. Transfer Characteristics

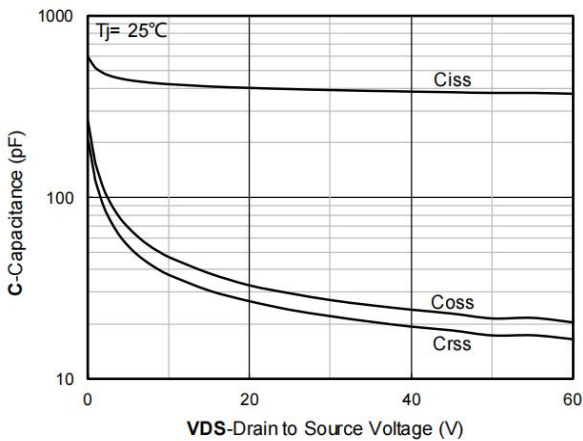


Figure 3. Capacitance Characteristics

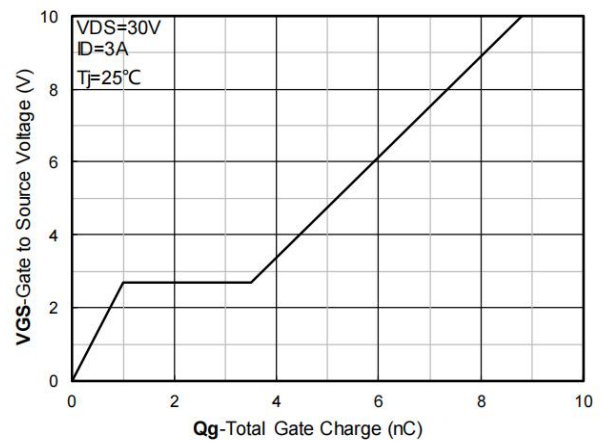


Figure 4. Gate Charge

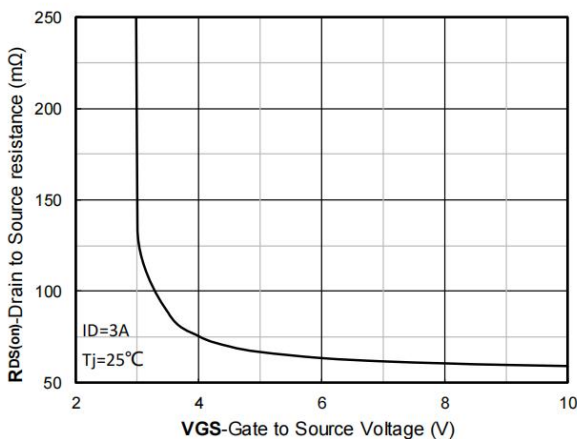


Figure 5. On-Resistance vs Gate to Source Voltage

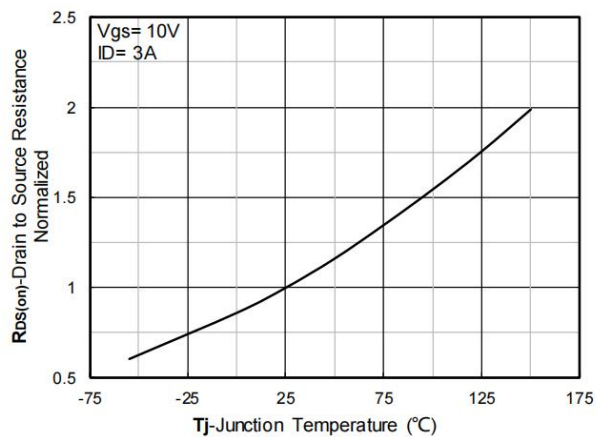


Figure 6. Normalized On-Resistance

Typical Characteristics

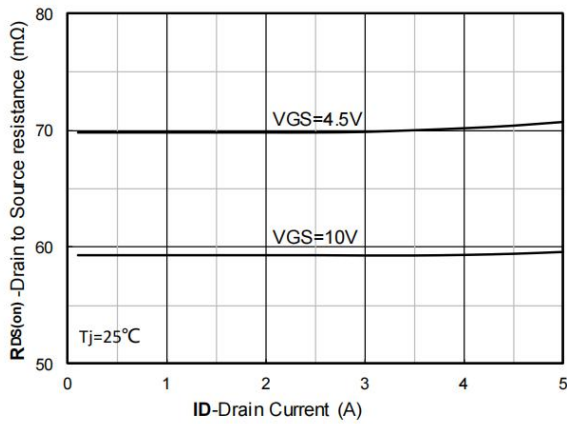


Figure 7. RDS(on) VS Drain Current

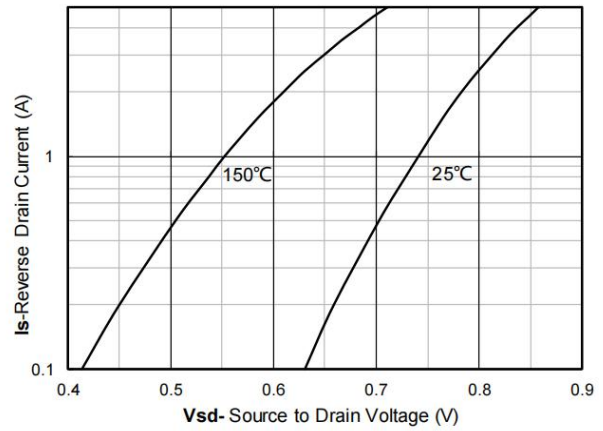


Figure 8. Forward characteristics of reverse diode

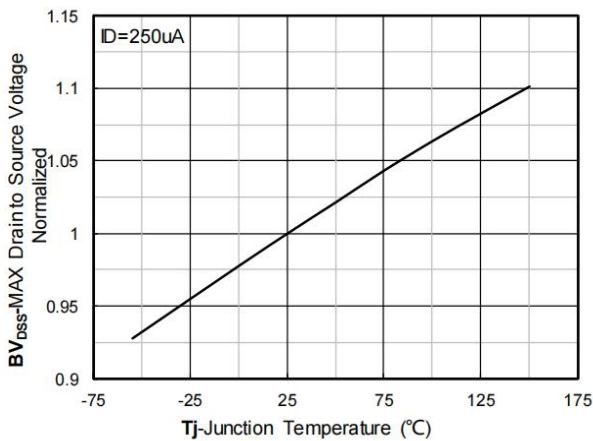


Figure 9. Normalized breakdown voltage

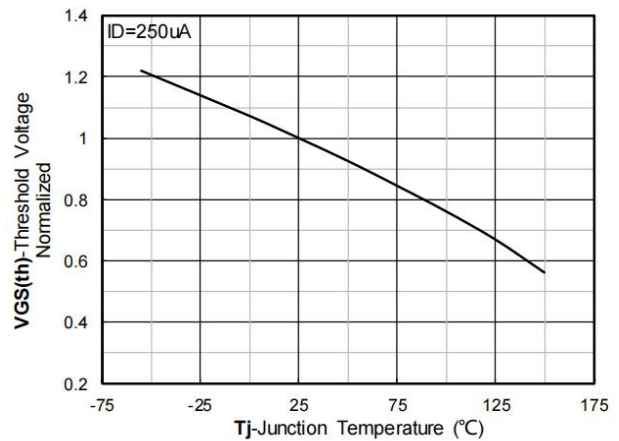


Figure 10. Normalized Threshold voltage

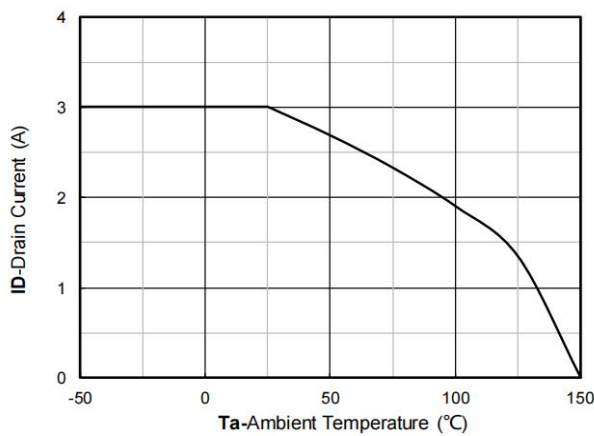


Figure 11. Current dissipation

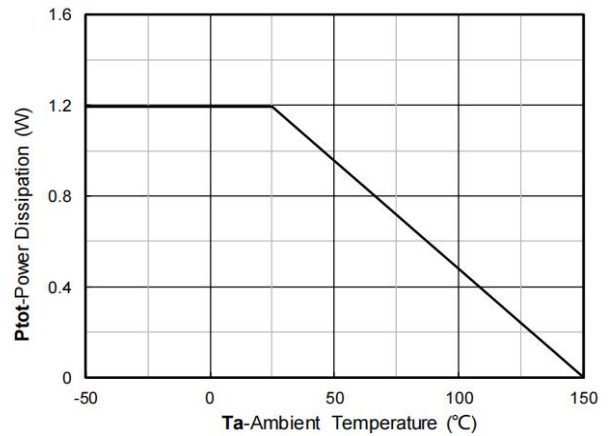


Figure 12. Power dissipation

Typical Characteristics

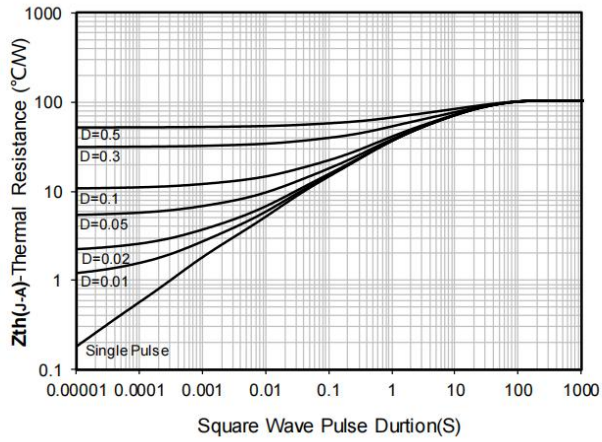


Figure 13. Maximum Transient Thermal Impedance

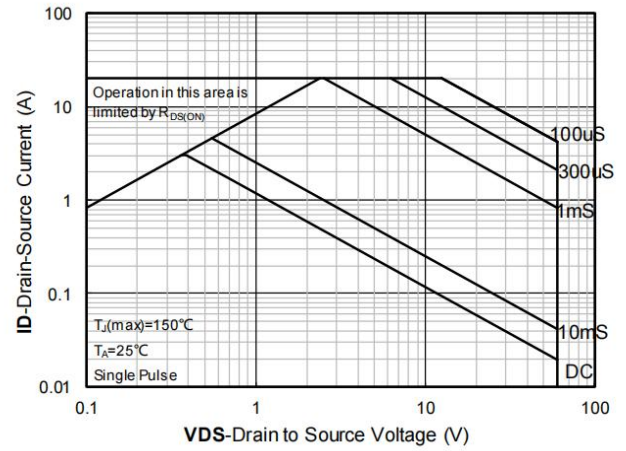
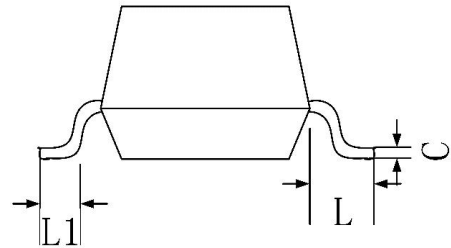
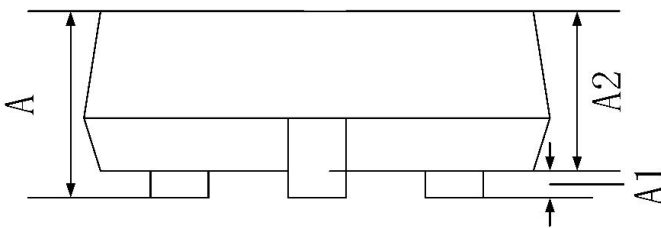
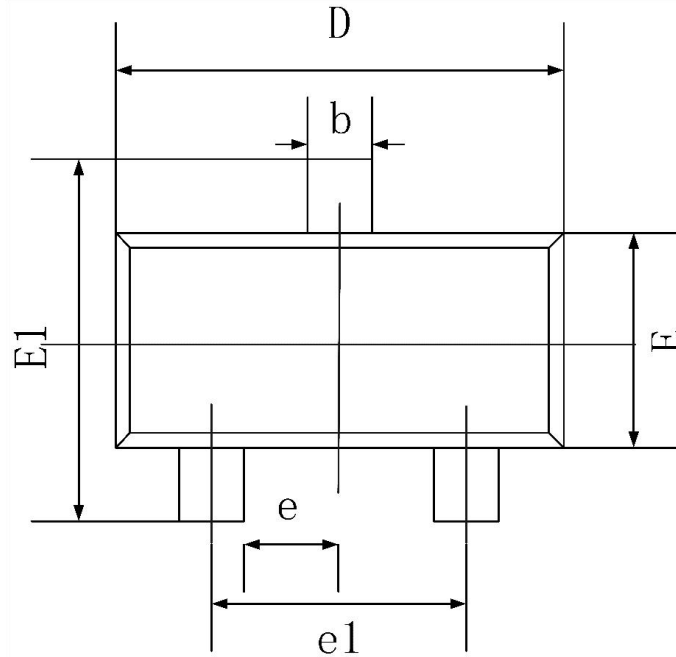


Figure 14. Safe Operation Area

SOT-23 Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 0.900 | 1.150 | 0.035 | 0.045 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 0.900 | 1.050 | 0.035 | 0.041 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.100 | 0.200 | 0.004 | 0.008 |
| D | 2.800 | 3.000 | 0.110 | 0.118 |
| E | 1.200 | 1.400 | 0.047 | 0.055 |
| E1 | 2.250 | 2.550 | 0.089 | 0.100 |
| e | 0.950 TYP. | | 0.037 TYP. | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.550 REF. | | 0.022 REF. | |
| L1 | 0.300 | 0.500 | 0.012 | 0.020 |